

FCH104N60F_F085

N-Channel SuperFET II FRFET MOSFET

600 V, 37 A, 104 mΩ

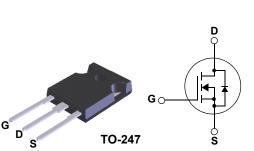
Features

- Typical $R_{DS(on)}$ = 91 m Ω at V_{GS} = 10 V, I_D = 18.5 A
- Typical Q_{a(tot)} = 109 nC at V_{GS} = 10V, I_D = 18.5 A
- UIS Capability
- Qualified to AEC Q101
- RoHS Compliant

Description

SuperFET® II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently SuperFETII is very well suited for the Soft switching and Hard Switching topologies like High Voltage Full Bridge and Half Bridge DC-DC, Interleaved Boost PFC, Boost PFC for HEV-EV automotive.

SuperFET II FRFET® MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.



For current package drawing, please refer to the Fairchild website at https://www.fairchildsemi.com/package-drawings/TO/ TO247A03.pdf

Application

- Automotive On Board Charger
- Automotive DC/DC converter for HEV



November 2014

Symbol	Parameter	Ratings	Units	
V _{DSS}	Drain to Source Voltage		600	V
V _{GS}	Gate to Source Voltage		±20	V
		T _C = 25°C	37	А
I _D	Drain Current - Continuous (V _{GS} =10) (Note 1)	T _C = 100°C	24	А
	Pulsed Drain Current		See Fig 4	А
E _{AS}	Single Pulse Avalanche Rating	(Note 2)	809	mJ
dv/dt	MOSFET dv/dt		100	V//mm
uv/ul	Peak Diode Recovery dv/dt	(Note 3)	50	V/ns
	Power Dissipation		357	W
P _D	Derate Above 25°C	2.85	W/ ^o C	
T _J , T _{STG}	Operating and Storage Temperature	-55 to + 150	°C	
$R_{\theta JC}$	Maximum Thermal Resistance Junction to Case	0.35	°C/W	
$R_{\theta JA}$	Maximum Thermal Resistance Junction to Ambie	ent (Note 4)	40	°C/W

Maximum Ratings T_C = 25°C unless otherwise noted

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FCH104N60F	FCH104N60F_F085	TO-247	-	-	30

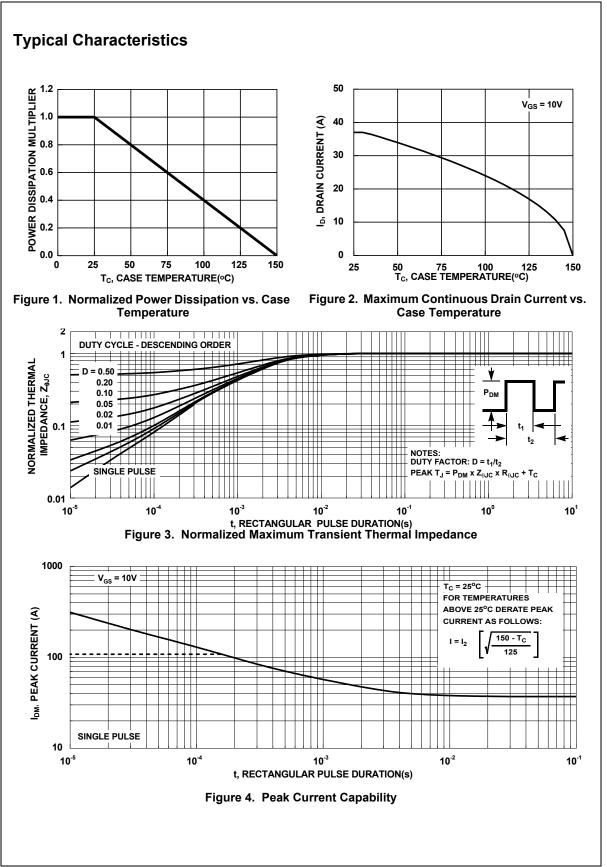
Notes:

1: Current is limited by bondwire configuration.

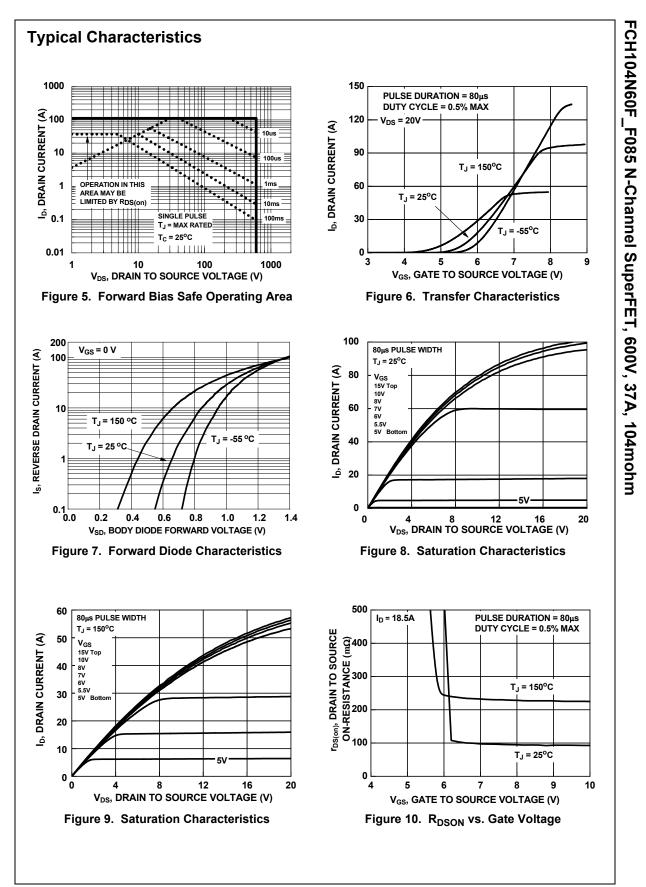
2: Starting T_J = 25°C, L = 35mH, I_{AS} = 6.8A, V_{DD} = 100V during inductor charging and V_{DD} = 0V during time in avalanche. 3: I_{SD} ≤ 18.5A, di/dt ≤ 200 A/us, V_{DD} ≤ 380V, starting T_J = 25°C.

4: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design, while R_{0JA}is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

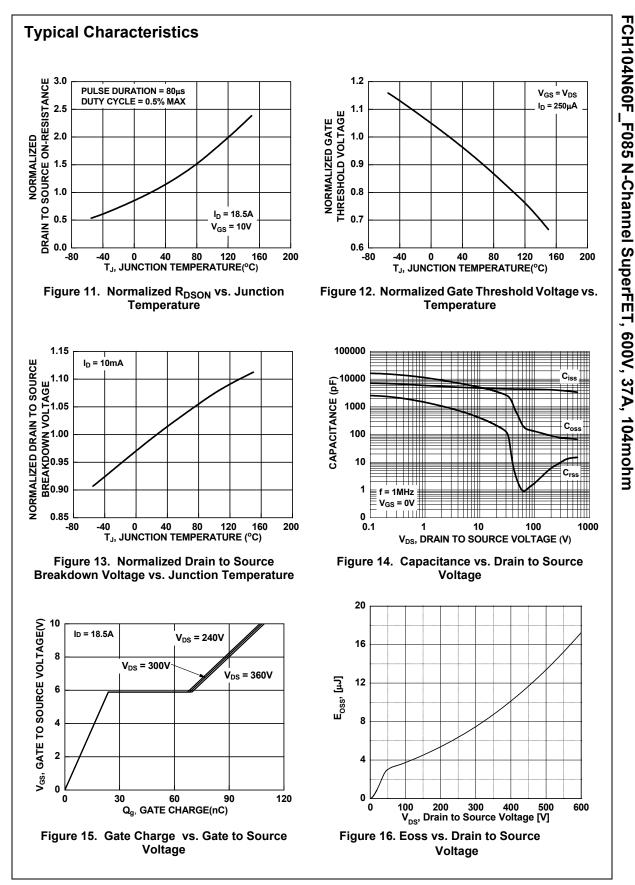
$\begin{array}{c cr} \hline l_{GSS} & \hline Gate to Source Leakage Current & V_{GS} = \pm 20V & - & - & \pm 100 \\ \hline V_{GS} = \pm 20V & - & - & \pm 100 \\ \hline V_{GS} = \pm 20V & - & - & \pm 100 \\ \hline On Characteristics & & & & & & \\ \hline V_{GS}(m) & \hline Drain to Source On Resistance & V_{GS} = V_{DS}, I_D = 250 \mu A & 3.0 & 4.0 & 5.0 \\ \hline I_D = 18.5A, & V_{GS} = 10V & T_J = 25^\circ C & - & 91 & 104 \\ \hline V_{JS} = 100V, V_{GS} = 10V & T_J = 150^\circ C(Note 5) & - & 217 & 275 \\ \hline Dynamic Characteristics & & & & \\ \hline C_{iss} & Input Capacitance & V_{DS} = 100V, V_{GS} = 0V, & - & 134 & - & - \\ \hline C_{coss} & Output Capacitance & f = 1MHz & - & 0.49 & - & - \\ \hline C_{coss} & Output Capacitance & f = 1MHz & - & 0.49 & - & - \\ \hline C_{rss} & Reverse Transfer Capacitance & f = 1MHz & - & 0.49 & - & - \\ \hline C_{gl}(ToT) & Total Gate Charge & V_{DD} = 380V & I_D = 18.5A & - & 8 & 11 & - & - \\ \hline Q_{gd} & Gate to Drain "Miller" Charge & V_{CS} = 10V & - & - & 46 & - & - \\ \hline Switching Characteristics & & & & \\ \hline t_{off} & Turn-On Time & V_{CS} = 10V, R_G = 4.7\Omega & - & - & 58 & 78 & - & - \\ \hline t_{off} & Turn-Off Time & & V_{CS} = 10V, R_G = 4.7\Omega & - & - & - & - & - & - \\ \hline T_{rr} & Reverse Recovery Time & I_F = 18.5A, V_{GS} = 0V & - & - & 1.2 & - & - & - & - \\ \hline T_{rr} & Reverse Recovery Time & I_F = 18.5A, V_{GS} = 0V & - & - & - & - & - & - & - & - & - & $	Symbol	Parameter	Test	Conditions	Min	Тур	Max	Units
$\begin{array}{ c c c c c c c c c } \hline \mbox{Drain to Source Leakage Current} & V_{DS}=600V, & T_J=25^{\circ}C & - & - & 10 \\ \hline \mbox{V}_{GS}=0V & T_J=150^{\circ}C(Note 5) & - & - & 1 \\ \hline \mbox{J}_{GSS} & Gate to Source Leakage Current} & V_{GS}=\pm 20V & - & - & \pm 100 \\ \hline \mbox{Dn Characteristics} & & & & & & & & & & & & & & & & & & &$	Off Cha	racteristics						
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	Bunss	Drain to Source Breakdown Voltage	I _D = 250μA, V	7 _{GS} = 0V	600	-	-	V
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$		-			-	-	10	μA
$\begin{array}{c c_{GSS} & Gate to Source Leakage Current & V_{GS} = \pm 20V & - & - & \pm 100 \\ \hline \\ \hline On Characteristics \\ \hline \\ \hline \\ \hline On Characteristics \\ \hline \\ $	I _{DSS}	Drain to Source Leakage Current			-	-	1	mA
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	I _{GSS}	Gate to Source Leakage Current		0 ()	-	-	±100	nA
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	On Cha	racteristics						
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Vcc(th)	Gate to Source Threshold Voltage	Vcc = Vpc Ir	a = 250µA	3.0	40	50	V
$\begin{array}{c c c c c c c } \hline \mbox{Data to Solute On Resistance} & V_{GS} = 10V & T_J = 150^{\circ}C(Note 5) & - & 217 & 275 \\ \hline \mbox{Dynamic Characteristics} \\ \hline \mbox{C}_{GS} & \mbox{Output Capacitance} & V_{DS} = 100V, V_{GS} = 0V, \\ \hline \mbox{f} = 1MHz & - & 134 & - & - & - & 134 & - & - & - & - & - & - & - & - & - & $	• GS(III)		$l_{\rm c} = 18.5$	$T_1 = 25^{\circ}C$	-			mΩ
$\begin{tabular}{ c c c c c c c } \hline Dynamic Characteristics \\ \hline Dynamic Characteristics \\ \hline C_{iss} & Input Capacitance & F = 10V, V_{GS} = 0V, & - & 4302 & - & - & 134 & - & - & - & 134 & - & - & - & 134 & - & - & - & 134 & - & - & - & 134 & - & - & - & 134 & - & - & - & 134 & - & - & - & 134 & - & - & - & 134 & - & - & - & - & 134 & - & - & - & - & 134 & - & - & - & - & 134 & - & - & - & - & - & 134 & - & - & - & - & - & 134 & - & - & - & - & - & 134 & - & - & - & - & - & - & 134 & - & - & - & - & - & - & 134 & - & - & - & - & - & - & - & - & - & $	r _{DS(on)}	Drain to Source On Resistance	$V_{GS} = 10V$		-			mΩ
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Dynami	ic Characteristics		•••••		1	1	1
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Cise	Input Capacitance			_	4302	-	pF
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Coss			V _{GS} = 0V,	-	134	-	, pF
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$			=t = 1MHz	-	-	1.7	-	, pF
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $			f = 1MHz		-	0.49	-	Ω
$ \begin{array}{ c c c c c c c c } \hline Source Gate Charge \\ Q_{g(th)} & Threshold Gate Charge \\ Q_{gs} & Gate to Source Gate Charge \\ Q_{gd} & Gate to Drain "Miller" Charge \\ \hline \\ $		Total Gate Charge	V _{DD} = 380V I _D = 18.5A		-	109	139	nC
$\begin{array}{c c c c c c c c c c c c c c c c c c c $		-			-	8	11	nC
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $					-	23	-	nC
3° - 12 Switching Characteristics t_{on} Turn-On Time - 58 78 $t_{d(on)}$ Turn-On Delay Time - 35 - - t_r Rise Time V_{DD} = 380V, I_D = 18.5A, - 23 - $t_{d(off)}$ Turn-Off Delay Time V_GS = 10V, R_G = 4.7\Omega - 94 - t_f Fall Time - 98 131 - Drain-Source Diode Characteristics V_SD Source to Drain Diode Voltage I_{SD} = 18.5A, V_{GS} = 0V - - 1.2 T_{rr} Reverse Recovery Time I _F = 18.5A, dI_{SD}/dt = 100A/µs - 162 - Q_{rr} Reverse Recovery Charge V_{DD} = 480V - 1223 -					-	46	-	nC
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Switch	ning Characteristics						
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	t _{on}	Turn-On Time		-	58	78	ns	
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	t _{d(on)}	Turn-On Delay Time			-	35	-	ns
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	t _r	Rise Time			-	23	-	ns
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	t _{d(off)}	Turn-Off Delay Time			-	94	-	ns
VsdSource to Drain Diode VoltageIsdIsdIsd V_{SD} Source to Drain Diode VoltageIsd18.5A, VGS = 0V1.2 T_{rr} Reverse Recovery TimeIF = 18.5A, dISd/dt = 100A/ μ s-162- Q_{rr} Reverse Recovery Charge V_{DD} = 480V-1223-	t _f	Fall Time		-	-	5	-	ns
V_{SD} Source to Drain Diode Voltage $I_{SD} = 18.5A$, $V_{GS} = 0V$ 1.2 T_{rr} Reverse Recovery Time $I_F = 18.5A$, $dI_{SD}/dt = 100A/\mu s$ -162- Q_{rr} Reverse Recovery Charge $V_{DD} = 480V$ -1223-	t _{off}	Turn-Off Time			-	98	131	ns
T_{rr} Reverse Recovery TimeIF= 18.5A, dI_{SD}/dt = 100A/µs-162- Q_{rr} Reverse Recovery Charge V_{DD} = 480V-1223-	Drain-S	ource Diode Characteristics						
T_{rr} Reverse Recovery TimeIF= 18.5A, dI_{SD}/dt = 100A/ μ s-162- Q_{rr} Reverse Recovery Charge V_{DD} = 480V-1223-	V _{SD}	Source to Drain Diode Voltage	I _{SD} = 18.5A, V _{GS} = 0V		-	-	1.2	V
Q_{rr} Reverse Recovery Charge $V_{DD} = 480V$ - 1223 -		Reverse Recovery Time	$I_F = 18.5A, dI_{SD}/dt = 100A/\mu s$		-	162	-	ns
		Reverse Recovery Charge	V _{DD} = 480V		-	1223	-	nC
NOIES:	Notes:							
5: The maximum value is specified by design at T _J = 150°C. Product is not tested to this condition in production.	5: The max	kimum value is specified by design at T_J = 150)°C. Product is no	t tested to this condition	in produc	tion.		



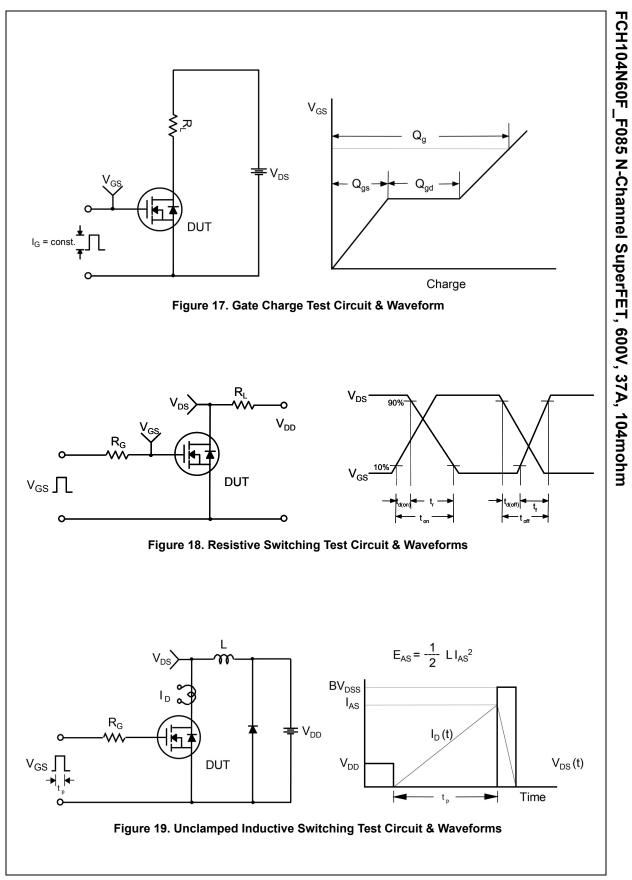
FCH104N60F_F085 N-Channel SuperFET, 600V, 37A, 104mohm



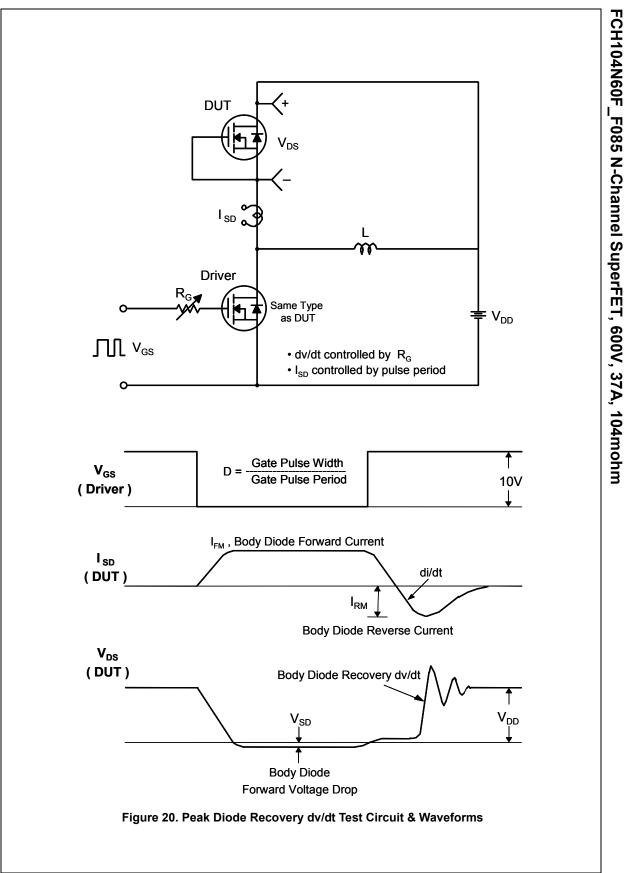
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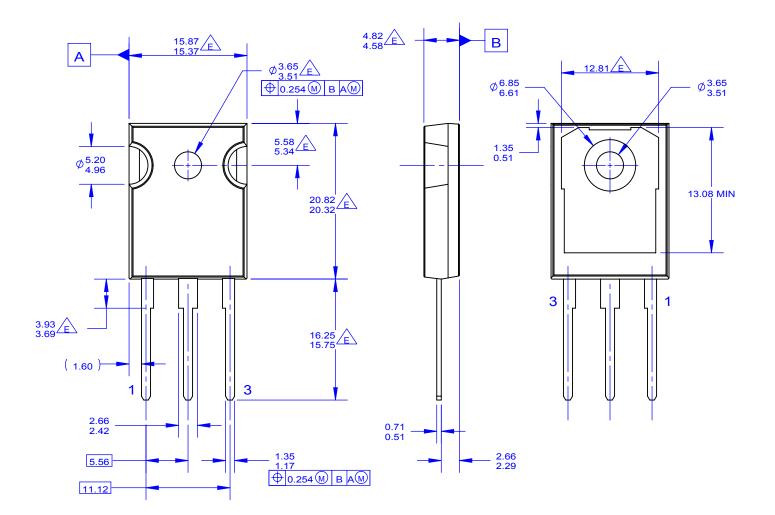






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